

This listing of claims replaces all prior versions and listings of claims in this application.

**LISTING OF CLAIMS:**

Claims 1-7 (Canceled)

Claim 8 (Currently Amended): ~~The~~ A cleaning solution ~~according to claim 1,~~  
~~wherein~~ for cleaning substrates of electronic materials consisting of:

(a) one or more organic acid compounds;

(b) at least one surfactant selected from the group consisting of anionic surfactants having a carboxyl group, naphthalenesulfonic acid and salts thereof, formaldehyde condensates and salts thereof, polymers with carboxylic acids, and lignosulfonic acid and salts thereof; and

(c) a water-soluble alcohol ~~is further comprised.~~

Claims 9-11 (Canceled)

Claim 12 (New): The cleaning solution according to claim 8, wherein the metallic impurities and the particle contamination adsorbed by a substrate are both removed at the same time.